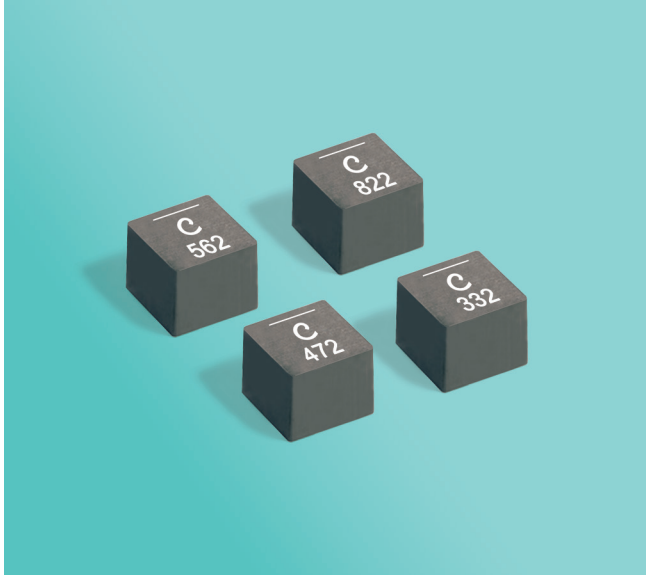


High-Reliability Power Inductors ML515PYA



- High temperature materials allow operation in ambient temperatures up to 155°C.
- Passes vibration testing to 80 G and shock testing to 1000 G
- High current and very low DCR
- Soft saturation makes them ideal for VRM/VRD applications.

Core material Composite

Terminations Tin-silver (96.5/3.5) over copper.

Weight 0.55 – 0.84 g

Ambient temperature –55°C to +105°C with Irms current

Maximum part temperature +155°C (ambient + temp rise).

Storage temperature Component: –55°C to +155°C.

Tape and reel packaging: –55°C to +80°C

Resistance to soldering heat Max three 40 second reflows at +260°C, parts cooled to room temperature between cycles

Moisture Sensitivity Level (MSL) 1 (unlimited floor life at <30°C / 85% relative humidity)

Enhanced crush-resistant packaging 250 per 7" reel
Plastic tape: 16 mm wide, 0.3 mm thick, 8 mm pocket spacing, 5.21 mm pocket depth

Part number ¹	Inductance ² ±20% (µH)	DCR (mOhm) ³		SRF (MHz) ⁴		Isat (A) ⁵	Irms (A) ⁶	
		typ	max	min	typ		20°C rise	40°C rise
ML515PYA561MLZ	0.56	4.15	4.56	77	96	18.1	10.7	14.3
ML515PYA821MLZ	0.82	5.15	5.66	50	63	14.8	8.9	12.4
ML515PYA122MLZ	1.2	6.16	6.76	43	54	12.9	8.7	11.9
ML515PYA152MLZ	1.5	7.10	7.80	38	48	11.5	8.4	11.6
ML515PYA222MLZ	2.2	9.05	9.95	33	41	9.5	6.8	9.5
ML515PYA332MLZ	3.3	16.90	18.60	27	34	7.4	5.3	7.0
ML515PYA472MLZ	4.7	21.95	24.15	23	29	6.3	4.6	6.2
ML515PYA562MLZ	5.6	23.45	25.80	20	25	5.7	4.0	5.4
ML515PYA682MLZ	6.8	26.75	29.45	17	21	5.4	3.5	4.8
ML515PYA822MLZ	8.2	31.75	34.95	14	18	5.1	3.4	4.6
ML515PYA103MLZ	10	40.90	45.00	12	15	4.6	2.7	3.7
ML515PYA153MLZ	15	69.70	76.70	10	13	3.5	2.2	2.9
ML515PYA223MLZ	22	90.60	99.65	9	11	2.8	1.9	2.6

1. When ordering, please specify **screening** code:

ML515PYA223MLZ

Screening: Z = Unscreened

Y = Unscreened (SLDC Option A)

W = Unscreened (SLDC Option B)

H = Group A screening per Coilcraft CP-SA-10001

G = Coilcraft CP-SA-10001 Group A (SLDC Option A)

D = Coilcraft CP-SA-10001 Group A (SLDC Option B)

All screening performed to the document's latest revision

2. Inductance tested at 100 kHz, 0.1 Vrms using an Agilent/HP 4192A.

3. DCR measured on a micro-ohmmeter.

4. SRF measured using Agilent/HP 4395A or equivalent.

5. DC current at 25°C that causes a 30% (typ) inductance drop from its value without current.

6. Current that causes the specified temperature rise from 25°C ambient. This information is for reference only and does not represent absolute maximum ratings.

7. Electrical specifications at 25°C.

Refer to Doc 362 "Soldering Surface Mount Components" before soldering.

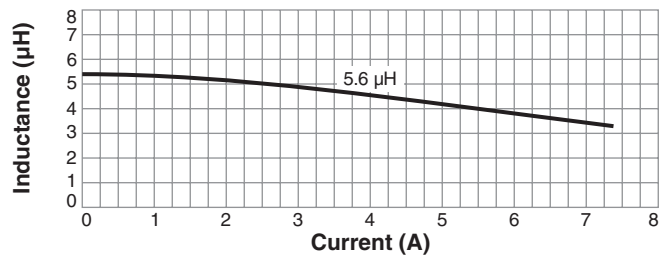
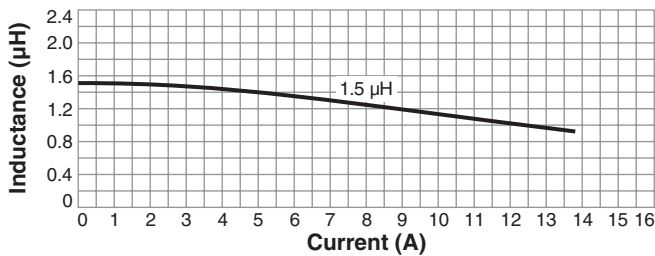
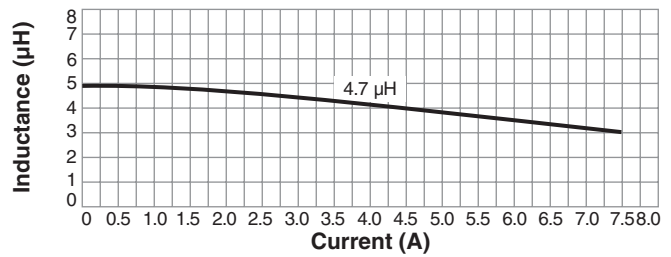
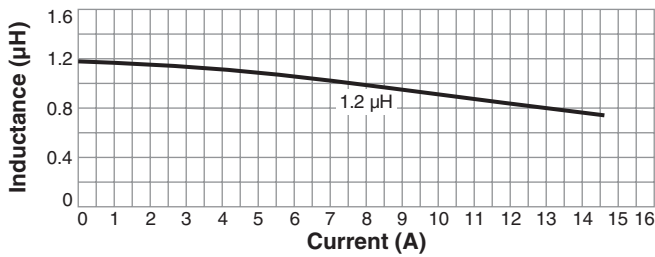
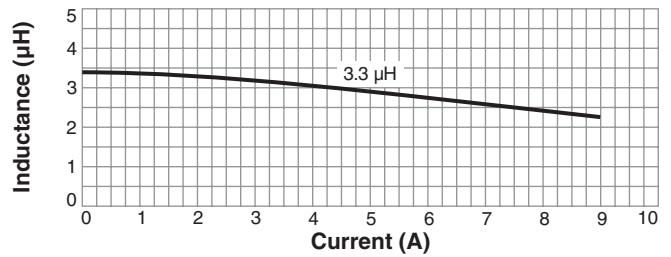
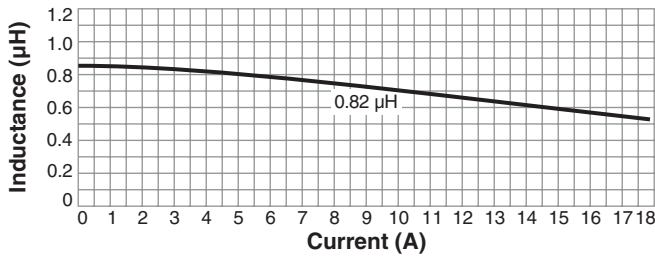
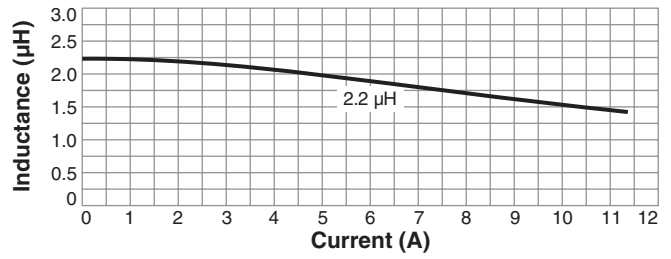
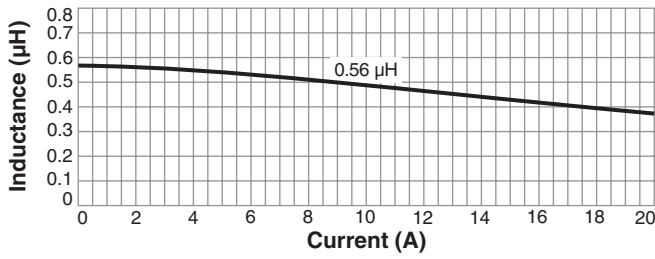
Irms Testing

Irms testing was performed on a 0.060" thick pcb with 4 oz. copper traces optimized to minimize additional temperature rise.

Temperature rise is highly dependent on many factors including pcb land pattern, trace size, and proximity to other components. Therefore temperature rise should be verified in application conditions.

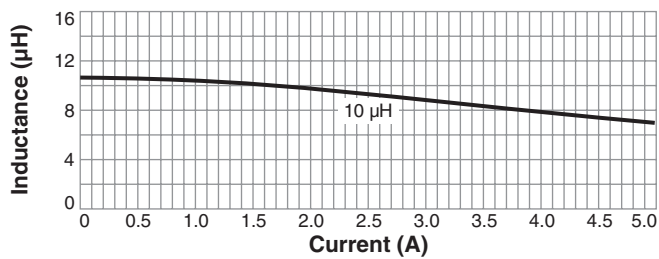
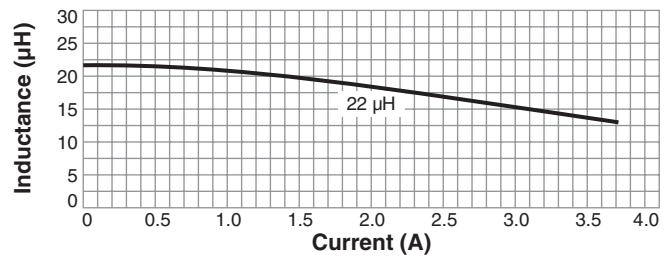
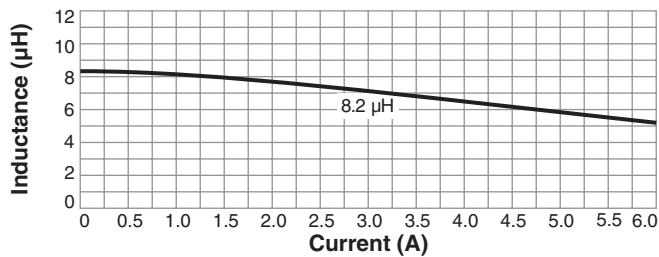
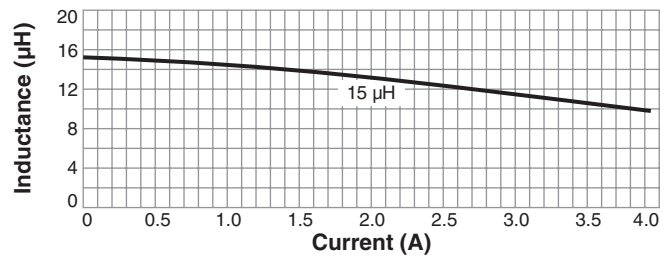
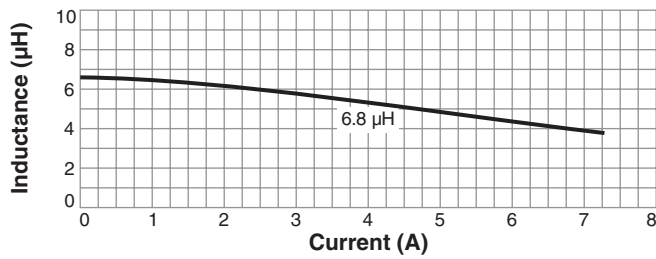
ML515PYA Series (5050)

Typical L vs Current



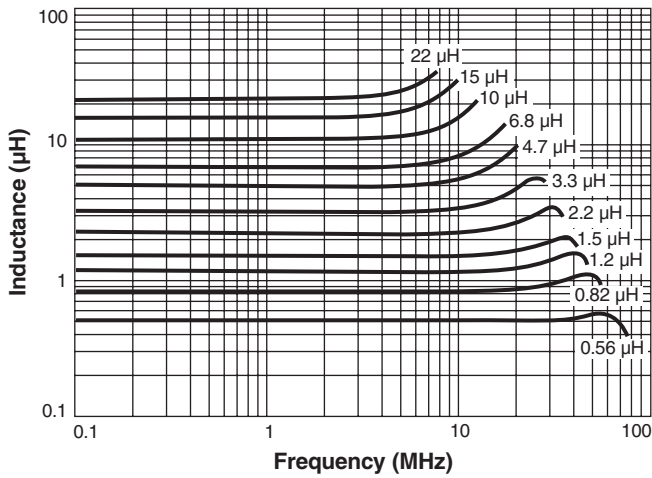
ML515PYA Series (5050)

Typical L vs Current

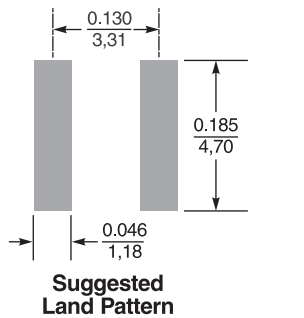
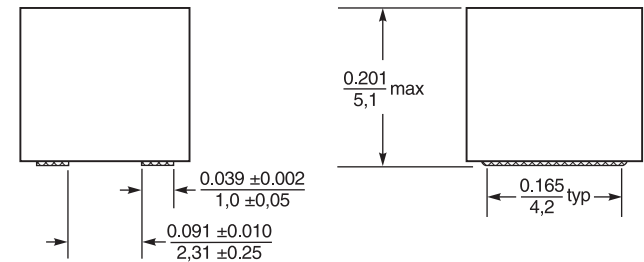
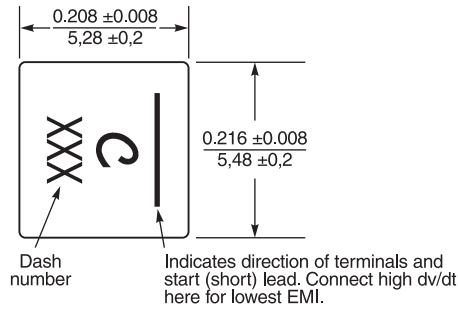
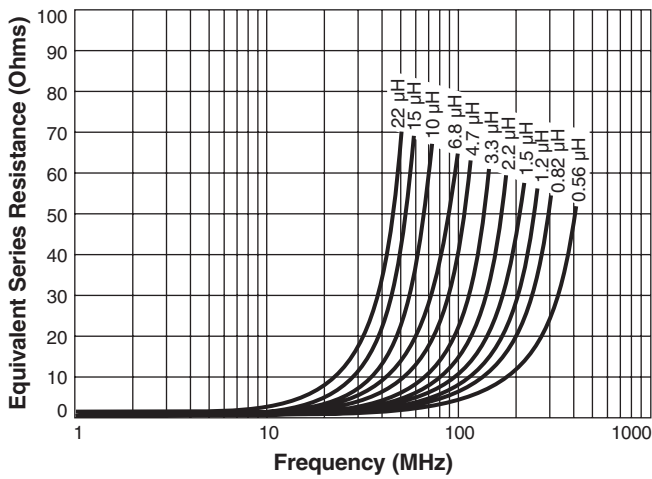


ML515PYA Series (5050)

Typical L vs Frequency



Typical ESR vs Frequency



Dimensions are in $\frac{\text{inches}}{\text{mm}}$